

<i>Notice of References Cited</i>		Application No. <i>09/228,694</i>		Applicant(s) <i>Pandya et al.</i>	
		Examiner <i>Sin J. Lee</i>		Group Art Unit <i>1752</i>	
Page <i>1</i> of <i>1</i>					
U.S. PATENT DOCUMENTS					
☆	DOCUMENT NO.	DATE	NAME		CLASS SUBCLASS
A					
B					
C					
D					
E					
F					
G					
H					
I					
J					
K					
L					
M					
FOREIGN PATENT DOCUMENTS					
☆	DOCUMENT NO.	DATE	COUNTRY	NAME	CLASS SUBCLASS
N	<i>JP 06049137A</i>	<i>02-22-94</i>	<i>Japanese</i>	<i>Watanabe et al.</i>	
O					
P					
Q					
R					
S					
T					
NON-PATENT DOCUMENTS					
☆	DOCUMENT (Including Author, Title, Source, and Pertinent Pages)				DATE
U	<i>Watanabe et al JPO abstract JP406049137A - English</i> <i>abstract of JP 06049137A (File: JPAB)</i>				<i>02-22</i> <i>-94</i>
V	<i>Watanabe et al Derwent abstract: 1994-097835 - English</i> <i>abstract of JP 06049137A (File: DWPZ)</i>				<i>02-22</i> <i>-94</i>
W					
X					

* A copy of this reference is not being furnished with this Office action.
 (See Manual of Patent Examining Procedure, Section 707.05(a).)